



P-Channel 20-V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	$R_{DS(on)}\left(\Omega\right)$	I _D (A)		
- 20	0.0073 at V _{GS} = - 4.5 V	- 20		
	0.0090 at V _{GS} = - 2.5 V	- 18		
	0.013 at V _{GS} = - 1.8 V	- 15		

PowerPAK SO-8

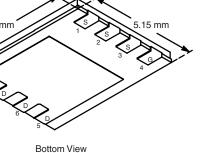
FEATURES

- Halogen-free According to IEC 61249-2-21 Available
- TrenchFET[®] Power MOSFETs
- New Low Thermal Resistance PowerPAK[®]
 Package with Low 1.07 mm Profile



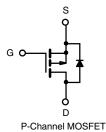
APPLICATIONS

· Battery Switch for Portable Devices



Ordering Information: Si7485DP-T1-E3 (Lead (Pb)-free)

Si7485DP-T1-GE3 (Lead (Pb)-free and Halogen-free)



ABSOLUTE MAXIMUM RATINGS T	A = 25 °C, unles	ss otherwise n	oted		
Parameter		Symbol	10 s	Steady State	Unit
Drain-Source Voltage		V_{DS}	- 20		V
Gate-Source Voltage		V_{GS}	± 8		
Continuous Drain Current (T _{.I} = 150 °C) ^a	T _A = 25 °C	I _D	- 20	- 12.5	A
Continuous Diain Current (1 _J = 150 °C)	T _A = 70 °C		- 16.5	- 9.5	
Pulsed Drain Current		I _{DM}	- 50		A
Continuous Source Current (Diode Conduction) ^a		I _S	- 4.5	- 1.6	
Maximum Power Dissipation ^a	T _A = 25 °C	P _D	5	1.8	W
Maximum Power Dissipation	T _A = 70 °C		3.2	1.1	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		°C
Soldering Recommendations (Peak Temperature) ^{b,c}		_	260		

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Manian and Lunching to Aughing to	t ≤ 10 s	R _{thJA}	20	25	°C/W
Maximum Junction-to-Ambient ^a	Steady State		54	68	
Maximum Junction-to-Case (Drain)	Steady State	R_{thJC}	1.7	2.2	

Notes:

- a. Surface Mounted on 1" x 1" FR4 board.
- b. See Solder Profile (www.vishay.com/ppg?73257). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- c. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

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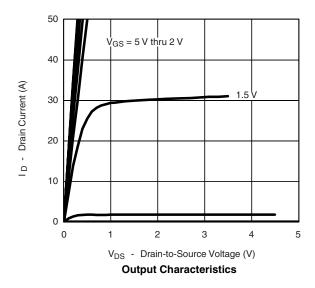
SPECIFICATIONS $T_J = 25$	°C, unless	otherwise noted					
Parameter	Symbol	Test Condition Min.		Тур.	Max.	Unit	
Static							
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = -1$ mA	- 0.4		- 0.9	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$			± 100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = - 20 V, V _{GS} = 0 V			- 1		
		V_{DS} = - 20 V, V_{GS} = 0 V, T_{J} = 70 °C			- 10	μΑ	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge -5 V$, $V_{GS} = -4.5 V$	- 40			Α	
Drain-Source On-State Resistance ^a		V _{GS} = - 4.5 V, I _D = - 20 A		0.006	0.0073	Ω	
	R _{DS(on)}	V _{GS} = - 2.5 V, I _D = - 18 A		0.0074	0.0090		
		V _{GS} = - 1.8 V, I _D = - 15 A		0.0106	0.013	ĺ	
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 20 A		80		S	
Diode Forward Voltage ^a	V_{SD}	I _S = - 4.5 A, V _{GS} = 0 V		- 0.62	- 1.1	V	
Dynamic ^b			•	•			
Total Gate Charge	Q_g			99	150		
Gate-Source Charge	Q_{gs}	V_{DS} = - 10 V, V_{GS} = - 5 V, I_D = - 20 A		11.5		nC	
Gate-Drain Charge	Q _{gd}			29		ı	
Gate Resistance	R_{g}			2.4		Ω	
Turn-On Delay Time	t _{d(on)}			80	120		
Rise Time	t _r	V_{DD} = - 10 V, R_L = 10 Ω		140	210	ns	
Turn-Off Delay Time		$I_D \cong -1$ A, $V_{GEN} = -4.5$ V, $R_g = 6 \Omega$		360	540		
Fall Time				170	260		
Source-Drain Reverse Recovery Time	t _{rr}	$I_F = -2.9 \text{ A, dI/dt} = 100 \text{ A/}\mu\text{s}$		55	80		

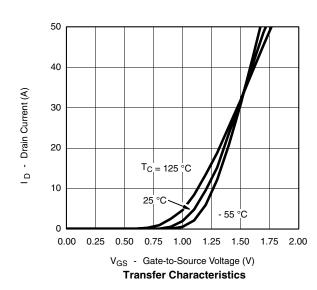
Notes:

- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %. b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





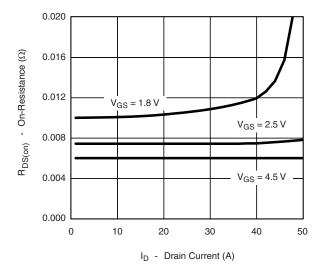




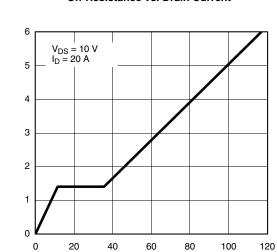


V_{GS} - Gate-to-Source Voltage (V)

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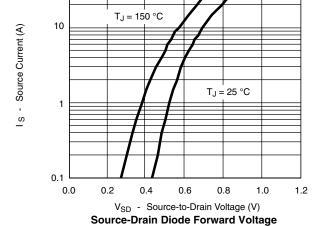


On-Resistance vs. Drain Current



Q_g - Total Gate Charge (nC)

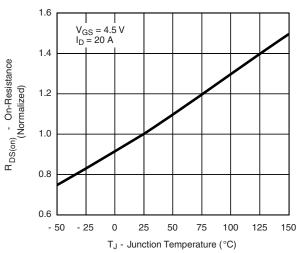
Gate Charge



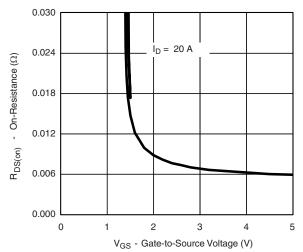
C_{iss} C_{rss}

V_{DS} - Drain-to-Source Voltage (V)

Capacitance



On-Resistance vs. Junction Temperature

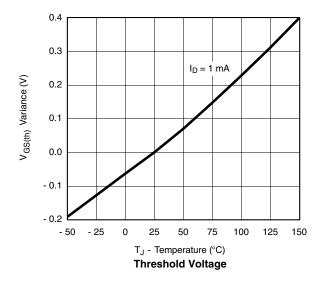


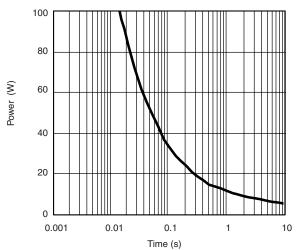
On-Resistance vs. Gate-to-Source Voltage

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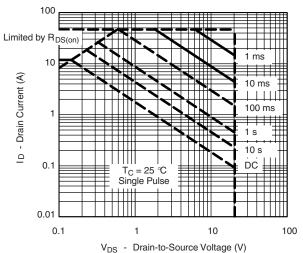
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

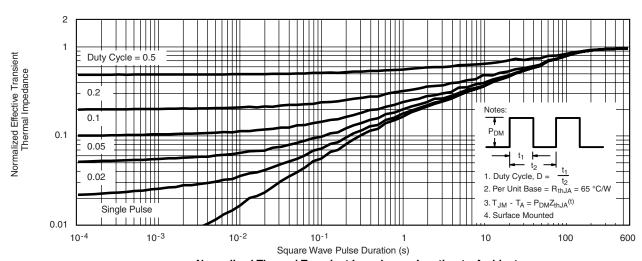




Single Pulse Power, Junction-to-Ambient



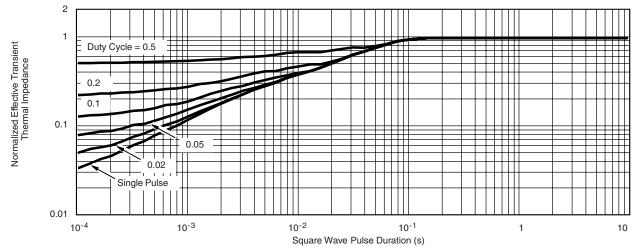
Safe Operating Area, Junction-to-Case



Normalized Thermal Transient Impedance, Junction-to-Ambient



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Case

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